

September 2022	
September 27, 2022	<p>Lego, Karl Reynders, Vice-President for Parts External Manufacturing</p> <p>Meeting subject: Developments around the Chips Act and the broader semiconductor supply issues</p>
September 28, 2022	<p>Flint-Global, Claus Grube, Senior Adviser</p> <p>Meeting subject: Curent Coreper I issues</p>